



MD[®] 250-CTH

Cationic Epoxy for Multiple Substrate Bonding

APPLICATIONS

- Catheter Assembly
- Endoscope Assembly
- Lens Positioning
- Tube Set Bonding

FEATURES

- UV/Visible Light Cure
- Heat Curing at 80-85°C
- Volumetric Shrinkage at 1.3%
- Semi-Opaque White Color
- High Modulus and Durometer

RECOMMENDED SUBSTRATES

- ABS
- PC
- PETG
- PS
- PU
- Glass

BIOCOMPATIBILITY

- ISO 10993-4 Hemolysis
- ISO 10993-5 Cytotoxicity
- ISO 10993-6 Implantation
- ISO 10993-10 Intracutaneous
- ISO 10993-11 Systemic Toxicity

Dymax MD[®] 250-CTH epoxy is designed for rapid assembly of medical devices with flexible curing options using light only, heat only, or any combination of the two. Dymax MD Medical Device Adhesives contain no nonreactive solvents and cure upon exposure to light. Their ability to cure in seconds enables faster processing, greater output, and lower processing costs. When cured with Dymax light-curing spot lamps, focused-beam lamps, or flood lamps, they deliver optimum speed and performance for device assembly. Dymax lamps offer the ideal balance of UV and visible light for the fastest, deepest cures. This product is in full compliance with RoHS directives 2015/863/EU.

UNCURED PROPERTIES *

Property	Value	Test Method
Solvent Content	No Nonreactive Solvents	N/A
Chemical Class	Epoxy	N/A
Appearance	Off White Opaque Gel	N/A
Soluble in	Organic Solvents	N/A
Density, g/ml	1.6	ASTM D1875
Viscosity, cP	52,500 (nominal)	DSTM 502‡
Shelf Life @ 1°C to 5°C from Date of Manufacture	7 months	N/A

CURED MECHANICAL PROPERTIES *

Property	Value	Test Method
Durometer Hardness	D90	ASTM D2240
Tensile at Break, MPa [psi]	51.7 [7,500]	ASTM D638
Elongation at Break, %	2	ASTM D638
Modulus of Elasticity, MPa [psi]	1,425 [260,800]	ASTM D638

OTHER CURED PROPERTIES *

Property	Value	Test Method
Boiling Water Absorption, % (2 h)	1.0	ASTM D570
Water Absorption, % (25°C, 24 h)	0.2	ASTM D570
Linear Shrinkage, %	0.11	DSTM 614‡
Glass Transition Tg, °C	141	ASTM D5418
CTE _{α1} , µm/m/°C	26	ASTM E831
CTE _{α2} , µm/m/°C	96	ASTM E831

CURING EQUIPMENT RECOMMENDATIONS *

Process Method	Spot Lamp	Flood Lamp	Conveyor
LED Curing/Wavelength	BlueWave [®] MX-150 RediCure (365 nm), PrimeCure (385 nm), VisiCure (405 nm)	BlueWave [®] MX-250 or AX-550 RediCure (365 nm), PrimeCure (385 nm), VisiCure (405 nm)	UVCS Conveyor with BlueWave [®] AX-550 RediCure (365 nm), PrimeCure (385 nm), VisiCure (405 nm)
Broad Spectrum	BlueWave [®] 200	5000-ECE	UVCS Conveyor with Fusion F300S

* Not Specifications

N/A Not Applicable

‡ DSTM Refers to Dymax Standard Test Method

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Technical Data Collected 12/2018 Rev. 3/11/2021





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ADHESION	
Substrate	Recommendation
ABS acrylonitrile-butadiene-styrene	✓
CAP cellulose acetate propionate	✓
PC polycarbonate	✓
PCTG poly(cyclohexylene dimethylene terephthalate)glycol	✓
PEBA polyether block amide	st
PEI polyetherimide	✓
PET poly(ethylene terephthalate)	o
PETG poly(ethylene terephthalate)glycol	✓
PI polyimide	o
PS polystyrene	✓
PU polyurethane	✓
PVC poly(vinyl chloride)	✓
SAN styrene-acrylonitrile	✓
GL borosilicate, quartz, mica glass	✓
PCB printed circuit board	✓

✓ Recommended o Limited Applications
st Requires Surface Treatment (e.g. plasma, corona treatment, etc.)

CURING GUIDELINES

Fixture time is defined as the time to develop a shear strength of 0.1 N/mm² [10 psi] between glass slides. Actual cure time typically is 3-to-5 times fixture time.

Dymax Curing System (Intensity)	Fixture Time or Belt Speed ^A
BlueWave® 200 (10 W/cm ²) ^B	0.8 s
BlueWave® MX-150 RediCure® 365 nm (15 W/cm ²) ^C	0.8 s
BlueWave® MX-150 PrimeCure® 385 nm (15 W/cm ²) ^C	0.6 s
BlueWave® MX-150 VisiCure® 405 nm (15 W/cm ²) ^C	0.8 s
5000-EC (200 mW/cm ²) ^B	3.0 s
BlueWave® MX-250 RediCure® 365 nm (250 mW/cm ²) ^C	4.8 s
BlueWave® MX-250 PrimeCure® 385 nm (250 mW/cm ²) ^C	4.2 s
BlueWave® MX-250 VisiCure® 405 nm (250 mW/cm ²) ^C	5.2 s

^A Fixture times/belt speeds are typical for curing thin films through 100% UV and light-transmitting substrates. Light-obstructing substrates may require longer cure times.

^B Intensity was measured over the UVA range (320-395 nm) using a Dymax ACCU-CAL™ 50 Radiometer.

^C Intensity was measured over the UVA/Visible range (350-450 nm) using a Dymax ACCU-CAL™ 50-LED Radiometer.

^D At 53 mm [2.1 in] focal distance. Maximum speed of conveyor is 8.2 m/min [27 ft/min]. Intensity was measured over the UVA range (320-395 nm) using the Dymax ACCU-CAL™ 160 Radiometer.



HEAT CURE

Heat can be used as a cure mechanism solely or in conjunction with light curing. The following heat-cure schedule may be used:

Temperature	Time*
80°C [176°F]	30-35 minutes
85°C [185°F]	20-25 minutes

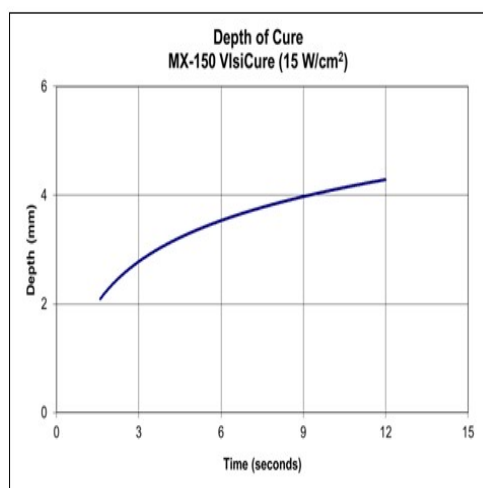
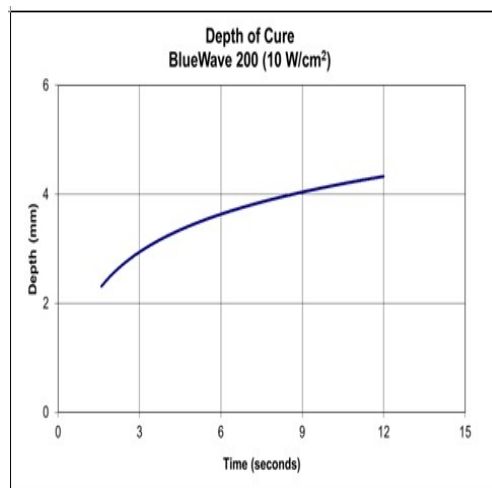
*Note: Actual heat cure time may vary due to part configuration, volume of adhesive applied, and oven efficiency.

Full cure is best determined empirically by curing at different times and intensities, and measuring the corresponding change in cured properties such as tackiness, adhesion, hardness, etc. Full cure is defined as the point at which more light or heat exposure no longer improves cured properties.

Dymax recommends that customers employ a safety factor by curing longer and/or at higher intensities than required for full cure. Although Dymax Application Engineering can provide technical support and assist with process development, each customer must ultimately determine and qualify the appropriate curing parameters required for their unique application.

DEPTH OF CURE

The graph below shows the increase in depth of cure as a function of exposure time. A 9.5 mm [0.37 in] diameter specimen was cured in a polypropylene mold and cooled to room temperature. It was then released from the mold and the cure depth was measured.



OPTIMIZING PERFORMANCE AND HANDLING

1. This product cures with exposure to UV and visible light. Exposure to ambient and artificial light should be kept to a minimum before curing. Dispensing components including needles and fluid lines should be 100% light blocking, not just UV blocking.
2. All bond surfaces should be clean and free from grease, mold release, or other contaminants prior to dispensing the adhesive.
3. Cure speed is dependent upon many variables, including lamp intensity, distance from the light source, required depth of cure, bond gap, and percent light transmission of the substrate.
4. High humidity environments or basic materials may inhibit cure.
5. Parts should be allowed to cool after cure before testing and subjecting to any loads.
6. In rare cases, stress cracking may occur in assembled parts. Three options may be explored to eliminate this problem. One option is to heat anneal the parts to remove molded-in stresses. A second option is to open the gap between mating parts to reduce stress caused by an interference fit. The third option is to minimize the amount of time the liquid adhesive remains in contact with the substrate(s) prior to curing.
7. Light curing generally produces some heat. If necessary, cooling fans can be placed in the curing area to reduce the heating effect on components.
8. At the point of curing, an air exhaust system is recommended to dissipate any heat and vapors formed during the curing process.

DISPENSING SUPPORT

The Dymax Application Engineering team is ready to discuss your application requirements to provide the most appropriate dispensing and/or spraying solution. Visit our current dispensing equipment portfolio [here](#) or consult our [global contact](#) phone numbers and online chat feature (available in North America only) during normal business hours for instant support.



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STORAGE AND SHELF LIFE

Store the material in a cool, dark place when not in use. Do not expose to light. This product may polymerize upon prolonged exposure to ambient and artificial light. Keep covered when not in use. This material shelf life is noted on page 1 of this document, when stored between 1°C (34°F) and 5°C (41°F) in the original container.

The pot life is 7 days at 25°C. Once material is removed from 1-5°C storage, it should be used in its entirety or disposed of within 7 days.

STERILIZATION

Compatible sterilization methods include gamma irradiation and ethylene oxide. Sterilization by autoclaving may be limited to certain applications. It remains the user's obligation to ascertain the effect of sterilization on the cured adhesive.

CLEAN UP

Uncured material may be removed from dispensing components and parts with organic solvents. Cured material will be impervious to many solvents and difficult to remove. Cleanup of cured material may require mechanical methods such as ultrasonic bath, water jet, vacuum tweezers, air knife and/ or warming to aid in the removal.

BIOCOMPATIBILITY

Polymerized Dymax MD® Medical Device Adhesives are biocompatibility tested in accordance with ISO 10993 and/or USP Class VI. The completed tests are listed on each product data sheet. Copies of the test reports are available upon request. In all cases, it is the user's responsibility to determine and validate the suitability of these adhesives in the intended medical device. These adhesives have not been tested for prolonged or permanent implantation and are only intended for use in short-term (<29 days) or single-use disposable-device applications. Dymax does not authorize their use in long-term implant applications. Customers using these materials for such applications do so at their own risk and take full responsibility for ensuring product safety and biocompatibility.

GENERAL INFORMATION

This product is intended for industrial use only. Keep out of the reach of children. Avoid breathing vapors. Avoid contact with skin, eyes, and clothing. Wear impervious gloves. Repeated or continuous skin contact with uncured material may cause irritation. Remove material from skin with soap and water. Never use organic solvents to remove material from skin and eyes. For more information on the safe handling of this material, please refer to the Safety Data Sheet before use.

The data provided in this document are based on historical testing that Dymax performed under laboratory conditions as they existed at that time and are for informational purposes only. The data are neither specifications nor guarantees of future performance in a particular application. Dymax does not guarantee that this product's properties are suitable for the user's intended purpose.

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